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Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

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We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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LIXYS

$I_{\text{FRMS}} = 2x \ 180 \ \text{A}$ **Diode Modules** $I_{FAVM} = 2x \ 113 \ A$ V_{RRM} = 800-1800 V 3 2 **TO-240 AA** $V_{\rm RSM}$ Type V_{RRM} MDD ۷ ۷ 3 1 2 MDD 72-08N1 B 900 800 MDA 72-08N1 B 1300 1200 MDD 72-12N1 B 1500 1400 MDD 72-14N1 B MDA 72-14N1 B 1700 1600 MDD 72-16N1 B MDA 72-16N1 B 1900 1800 MDD 72-18N1 B MDA I Symbol **Test Conditions Maximum Ratings** Features $T_{vJ} = T_{vJM}$ $T_{c} = 92^{\circ}C; 180^{\circ} \text{ sine}$ 180 А JEDEC TO-240 AA 113 А FAVM $T_{c}^{\circ} = 100^{\circ}C; 180^{\circ}$ sine 99 А base plate $T_{VJ} = 45^{\circ}C;$ t = 10 ms (50 Hz), sine 1700 А I_{FSM} · Planar passivated chips $V_{R} = 0$ t = 8.3 ms (60 Hz), sine 1950 А Isolation voltage 3600 V~ $T_{VJ} = T_{VJM}$ t = 10 ms (50 Hz), sine 1540 Α • UL registered, E 72873 $V_{\rm B}^{10} = 0$ t = 8.3 ms (60 Hz), sine 1800 А $T_{VJ} = 45^{\circ}C$ ∫i²dt t = 10 ms (50 Hz), sine 14 450 A²s Applications $V_{R}^{v_{3}} = 0$ t = 8.3 ms (60 Hz), sine 15 700 A²s t = 10 ms (50 Hz), sine $\mathsf{T}_{\mathsf{VJ}} = \mathsf{T}_{\mathsf{VJM}}$ 11 850 A²s · DC supply for PWM inverter $V_{R} = 0$ t = 8.3 ms (60 Hz), sine A²s 13 400 Field supply for DC motors °C \mathbf{T}_{vJ} -40...+150 · Battery DC power supplies °C T_{VJM} 150 T_stg °C -40...+125 **Advantages** VISOL V~ 50/60 Hz, RMS t = 1 min3000 Space and weight savings $I_{\rm ISOL} \le 1 \ mA$ 3600 V~ t = 1 sSimple mounting Mounting torque (M5) 2.5-4/22-35 Nm/lb.in. M_d cycling Terminal connection torque (M5) 2.5-4/22-35 Nm/lb.in. Reduced protection circuits Weight Typical including screws 90 g Symbol **Test Conditions Characteristic Values** I_R $T_{VJ} = T_{VJM}; V_R = V_{RRM}$ 15 mA M5x10 V_F $I_{F} = 300 \text{ A}; T_{VI} = 25^{\circ}\text{C}$ V 1.6 V_{T0} For power-loss calculations only 0.8 ۷ $T_{VJ} = T_{VJM}$ 2.3 mΩ r_T $\mathbf{\bar{Q}}_{\mathrm{s}}$ $T_{vJ} = 125^{\circ}C; I_{F} = 50 \text{ A}, -di/dt = 3 \overline{A/\mu s}$ 170 μC 45 А 65 I_{RM} $\mathbf{R}_{\mathrm{thJC}}$ K/W 0.35 per diode; DC current -20· 20 other values K/W per module 0.175 $\mathbf{R}_{_{\mathrm{thJK}}}$ per diode; DC current K/W see Fig. 6/7 0.55 per module 0.275 K/W d_s Creepage distance on surface 12.7 mm ุ่รุก d Strike distance through air 9.6 mm .92 Maximum allowable acceleration

50

m/s²

Data according to IEC 60747 and refer to a single diode unless otherwise stated IXYS reserves the right to change limits, test conditions and dimensions

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- · International standard package
- Direct copper bonded Al₂O₂ -ceramic
- Supplies for DC power equipment
- Improved temperature and power

Dimensions in mm (1 mm = 0.0394")









Fig. 2 ji2dt versus time (1-10 ms)





Fig. 3 Power dissipation versus forward current and ambient temperature (per diode)





- Fig. 4 Single phase rectifier bridge: Power dissipation versus direct output current and ambient temperature R = resistive load
 - L = inductive load





Fig. 5 Three phase rectifier bridge: Power dissipation versus direct output current and ambient temperature

Fig. 6 Transient thermal impedance junction to case (per diode)

 ${\rm R}_{_{\rm thJC}}$ for various conduction angles d:

d	R _{thJC} (K/W)
DC	0.35
180°	0.37
120°	0.39
60°	0.43
30 °	0.47

Constants for Z_{thJC} calculation:

i	R _{thi} (K/W)	t _i (s)
1	0.013	0.0014
2	0.072	0.062
3	0.265	0.375

Fig. 7 Transient thermal impedance junction to heatsink (per diode)

 $\mathbf{R}_{_{thJK}}$ for various conduction angles d:

d	R _{thJK} (K/W)
DC	0.55
180°	0.57
120°	0.59
60°	0.63
30°	0.67

Constants for $\boldsymbol{Z}_{_{thJK}}$ calculation:

i	R _{thi} (K/W)	t _i (s)
1	0.013	0.0014
2	0.072	0.062
3	0.265	0.375
4	0.2	1.32



